



AP22916

1.3V-5.5V, 2A, 60mΩ ULTRA-LOW LEAKAGE LOAD SWITCH

Description

The AP22916 is a small, low leakage, single P-channel power MOSFET designed for low-power consumption, load-switching applications. The power MOSFET has a typical $R_{\rm DS(ON)}$ of $60 {\rm m}\Omega$ at 5V, allowing increased load current handling capacity with a low forward voltage drop. Multiple voltages correspond to different time options to support various system load conditions. The trigger of the load switch ON pin can be controlled to be enabled or disabled by an external low voltage digital signal for sequence control application. Smart pull down feature is built in the ON pin. Once the enable voltage is higher than $V_{\rm IH}$, it will disconnect to avoid power loss. $V_{\rm IN}$ and $V_{\rm OUT}$ are isolated during OFF state with the TRCB (Truly Reverse Current Blocking) feature.

The AP22916 load switch is designed to operate from 1.3V to 5.5V, making it ideal for 1.3V, 1.8V, 2.5V, 3.6V, and 5V systems. The typical quiescent supply current is only $0.5\mu A$.

The AP22916 is available in the wafer level chip scale 4-pin, X1-WLB0808-4 0.78mm x 0.78mm x 0.455mm, 0.4mm pitch package. The device is characterized for operation over a temperature range of -40° C to $+85^{\circ}$ C.

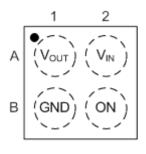
Features

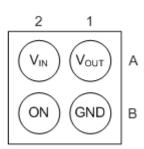
- Wide Input Voltage Range: 1.3V to 5.5V
- Low On-Resistance
 - 150mΩ Typical @1.3V
 - 100mΩ Typical @1.8V
 - 70mΩ Typical @3.6V
 - 60mΩ Typical @5.0V
- Continuous Current Capability up to 2A
- Truly Reverse Current Blocking (TRCB)
- Discharging Resistor on V_{OUT} When Disabled
- Ultra Low Quiescent Current 0.5µA
- Active-high Control Pin
 - Minimum 1.0V V_{IH} of ON
- ESD Protection:
 - Human Body Model: 2kV
 - Charged Device Model: 1kV
- Package:
 - X1-WLB0808-4 with Backside Laminate
 - 0.78mm x 0.78mm, 0.4mm Ball Pitch
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Notes 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Pin Assignments

X1-WLB0808-4





Top View

Bottom View

Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Wearable Devices
- Advanced Notebook, UMPC, and MID
- Portable Medical Devices
- GPS and Navigation Equipment

Part Comparison Table

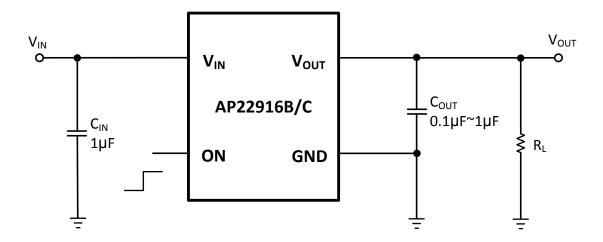
Version	rsion Timing Output Discharge		Enable
AP22916B	Fast	Yes	Active High
AP22916C	Slow	Yes	Active High

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Typical Applications Circuit

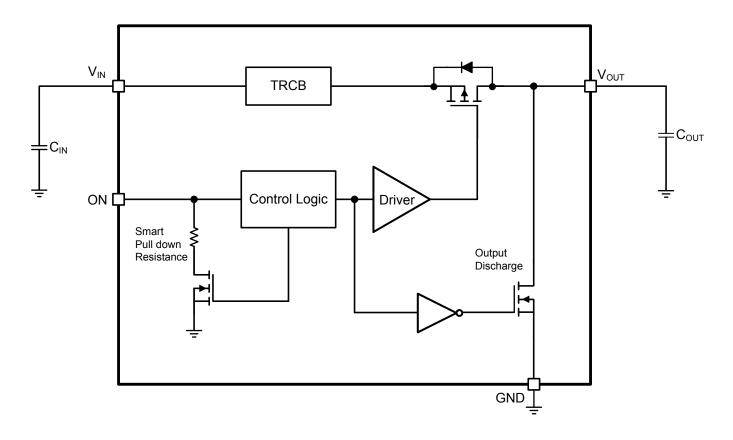


Pin Descriptions

Pin Name	Pin Number	Function
V _{OUT}	A1	Voltage output pin. This is the pin to the P-channel MOSFET drain connection. Bypass to ground through a $0.1\mu F$ or $1\mu F$ capacitor.
V _{IN}	A2	Voltage input pin. This is the pin to the P-channel MOSFET source. Bypass to ground through a $1\mu F$ capacitor.
GND	B1	Ground.
ON	B2	Enable input



Functional Block Diagram



Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Ratings	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
V _{IN}	Input Voltage	-0.3 to 6	V
V _{OUT}	Output Voltage	-0.3 to 6	V
Von	ON Voltage	-0.3 to 6	V
I _{LOAD}	Maximum Continuous Load Current	2	Α
I _{LOAD}	Maximum Pulse Load Current, Pulse <300µs, 2% Duty Cycle	2.5	А
T_J	Maximum Junction Temperature	+125	°C
T _{ST}	Storage Temperature Range	-65 to +150	°C
P_{D}	Power Dissipation	510	mW
R _{0JA}	Thermal Resistance, Junction to Ambient (Note 4)	195	°C/W
R ₀ JC	Thermal Resistance, Junction to Case (Note 5)	38	°C/W

Notes:

- 4. The JEDEC high-K (2s2p) board used to derive this data was a 3 inch x 3 inch, multilayer board with 1oz internal power and ground planes with 2oz copper traces on top and bottom of the board.
- 5. Thermal resistance from junction to case.

Caution:

Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.



Recommended Operating Conditions (@ T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	1.3	5.5	V
V _{ON}	ON Voltage Range	0	5.5	V
V _{OUT}	Output Voltage	1.3	5.5	V
la	Output Current while Vin≥1.5V	0	2.0	Α
Іоит	Output Current while Vin≤1.5V	0	1.0	A
V _{IH}	ON High-Level Input Voltage	1.0	5.5	V
VIL	ON Low-Level Input Voltage	0	0.35	V
TA	Operating Ambient Temperature	-40	+85	°C

Electrical Characteristics ($T_A = -40^{\circ}C$ to +85°C, $V_{IN} = 1.3$ to 5.5V, $V_{ON} = V_{IN}$ (Enabled), $V_{ON} = 0V$ (Disabled), $C_{IN} = 1\mu F$, $C_{OUT} = 0.1\mu F$, unless otherwise specified. Typical values are at 25°C) (Note 6)

Symbol	Parameters	Test Co	onditions	Min	Тур	Max	Unit
ΙQ	Input Quiescent Current	I _{OUT} = 0mA, V _{ON} Ena	bled	_	0.3	0.5	μΑ
		$R_L = 1M\Omega, V_{ON}$	+25°C	_	40	_	
		Disabled, V _{IN} =5.0V	-40°C to +85°C	_	_	225	nA
I _{SHDN}	Input Shutdown Current	$R_L = 1M\Omega, V_{ON}$	+25°C	_	5	_	IIA.
		Disabled, V _{IN} =1.8V	-40°C to +85°C	_	_	20	
			+25°C	_	54	60	
		V _{IN} = 5.0V	-40°C to +85°C	_	60	70	
			-40°C to +105°C	_	65	75	
	Switch On-resistance, I _{OUT} = 200mA	V _{IN} = 3.6V	+25°C	_	65	75	mΩ
			-40°C to +85°C	_	75	85	
			-40°C to +105°C	_	80	90	
R _{DS(ON)}		V _{IN} = 1.8V	+25°C	_	135	150	
			-40°C to +85°C	_	150	165	
			-40°C to +105°C	_	160	180	
		V _{IN} = 1.3V	+25°C	_	280	310	
			-40°C to +85°C	_	290	320	
			-40°C to +105°C	_	300	350	
Ron	Smart Pull Down Resistance	V _{ON} Disabled		_	750	_	kΩ
V _{RCB}	TRCB Trigger Voltage	V _{ON} Enabled, V _{OUT} > V _{IN}		_	25	_	mV
I _{RCB}	TRCB Activation Current	V _{IN} =3.3V, V _{ON} Enabled, V _{OUT} > V _{IN}		_	-650	_	mA
t _{RCB}	TRCB Response Time	V _{ON} Enabled, V _{OUT} > V _{IN} + 200mV		_	10	_	μs
	TRCB Reverse Leakage Current			-300			_
I _{IN_RCB}	(Current from V _{IN})	V _{ON} Enabled, V _{OUT} - V	V_{ON} Enabled, V_{OUT} - V_{IN} > V_{RCB}		_	_	nA
R _{DIS}	Output Discharge On Resistance	V _{ON} Disabled, I _{OUT} =	1mA	_	150	_	Ω

Note: 6. Specifications are over -40°C to +85°C and are guaranteed by characterization and design.



Timing Characteristics (The typical characteristics in the following table applies over the entire recommended power supply voltage range of 1.3V to 5.5V at 25°C with a load of $C_{OUT} = 0.1 \mu F$, $R_L = 10 \Omega$, unless otherwise specified.) (Note 7)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Unit
AP22916B						
		V _{IN} = 5.0V	_	85	_	
	Outside Transport	V _{IN} = 3.6V	_	110	-	
t _{ON}	Output Turn-on	V _{IN} = 1.8V		250	_	μs
		V _{IN} = 1.3V	_	480	-	
		V _{IN} = 5.0V	_	42	-	
4	Output Diag Time	V _{IN} = 3.6V	_	52	-	μs
t _R	Output Rise Time	V _{IN} = 1.8V	_	95	-	
		V _{IN} = 1.3V	_	180	-	
	Slew Rate	V _{IN} = 5.0V	_	90	-	mV/μs
0.0		V _{IN} = 3.6V	_	52	-	
SR _{ON}		V _{IN} = 1.8V	_	13	-	
		V _{IN} = 1.3V	_	5	_	
		V _{IN} = 5.0V	_	6.4	_	
	Outrant Towns off Times	V _{IN} = 3.6V	_	8	-	μs
toff	Output Turn-off Time	V _{IN} = 1.8V	_	16	-	
		V _{IN} = 1.3V	_	25	_	
	Outrout Fall Time	$C_{OUT} = 0.1 \mu F$, $R_L = 10 \Omega$		2.3	_	
t _F	Output Fall Time	C _{OUT} = 1µF, R _L = Open	_	357	_	μs

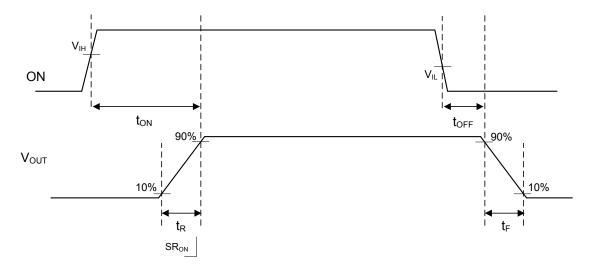
Symbol	Parameters	Test Conditions	Min	Тур	Max	Unit	
AP22916C	AP22916C						
		V _{IN} = 5.0V	_	1400	_		
	Output Turn on	V _{IN} = 3.6V	_	1700	_		
ton	Output Turn-on	V _{IN} = 1.8V	_	3800	_	μs	
		V _{IN} = 1.3V		6800	_		
		V _{IN} = 5.0V		750	_		
	Output Rise Time	$V_{IN} = 3.6V$		900	_	μs	
t _R		V _{IN} = 1.8V		1500	_		
		V _{IN} = 1.3V	_	2800	_		
	Slew Rate	V _{IN} = 5.0V	_	5	_	- mV/μs	
ep.		V _{IN} = 3.6V	_	3.2	_		
SR _{ON}		V _{IN} = 1.8V	_	1	_		
		V _{IN} = 1.3V	_	0.4	_		
		V _{IN} = 5.0V	_	7.1	_		
	Output Turn off Time	V _{IN} = 3.6V	_	8	_	- µs	
t _{OFF}	Output Turn-off Time	V _{IN} = 1.8V	_	16	_		
		V _{IN} = 1.3V	_	25	_		
	Output Fall Time	$C_{OUT} = 0.1 \mu F, R_L = 10 \Omega$	_	2.3	_		
t _F	Output Fall Time	C _{OUT} = 10µF, R _L = Open	_	4490	_	μs	

Note: 7. Rise and fall time of the control signal are less than 100ns.



Timing Characteristics (The typical characteristics in the following table applies over the entire recommended power supply voltage range of 1.3V to 5.5V at 25°C with a load of $C_{OUT} = 0.1 \mu F$, $R_L = 10 \Omega$, unless otherwise specified.) (Note 7) (Cont.)

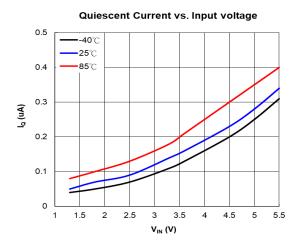
Timing for Power Up and Power Down Operation

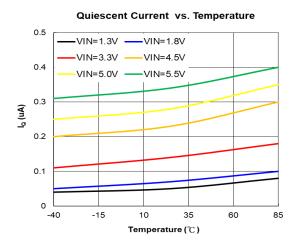


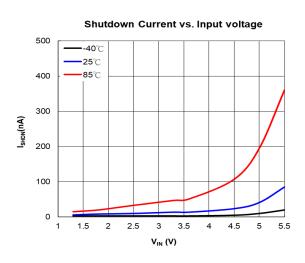
Output Rise (t_R), Fall (t_F), Turn On (t_{ON}) and Turn Off (t_{OFF}) Time

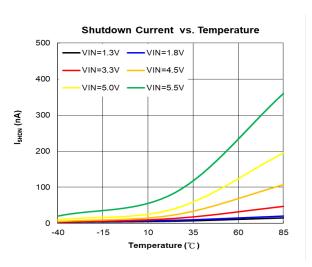
Note: 7. Rise and fall time of the control signal are less than 100ns.

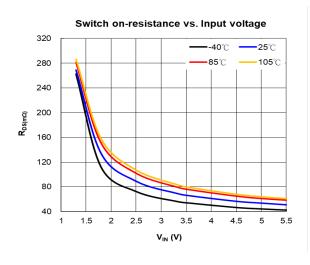


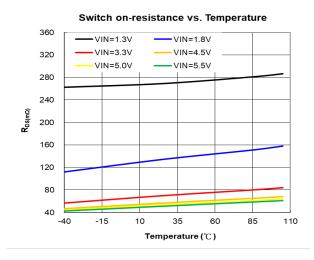




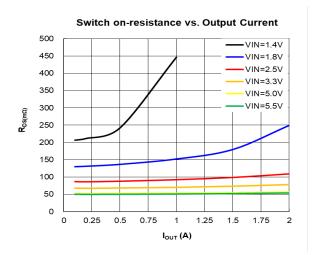


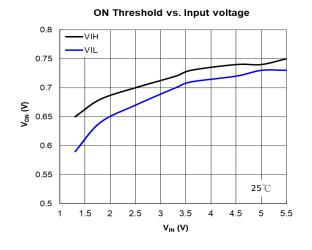


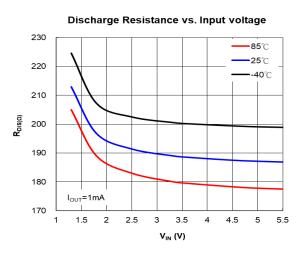


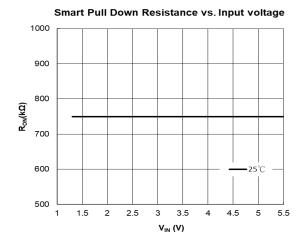




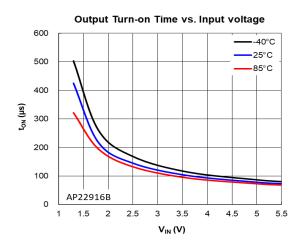


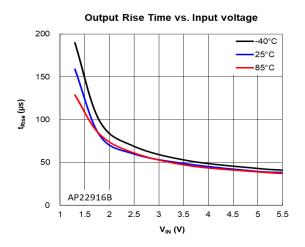


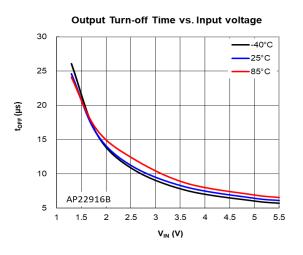


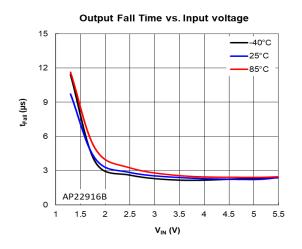


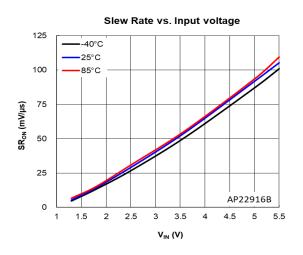




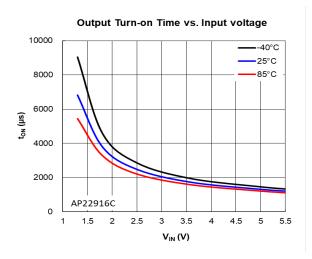


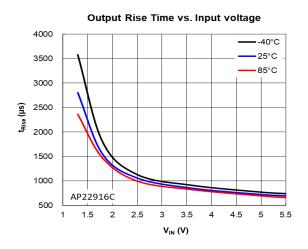


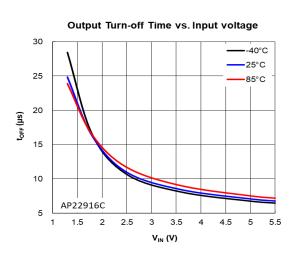


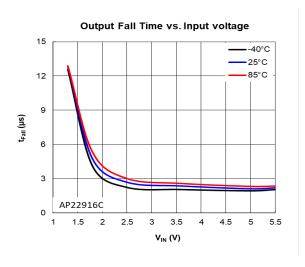


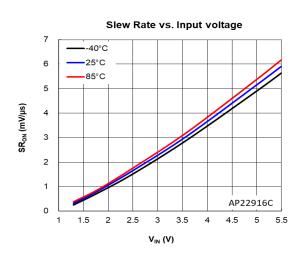




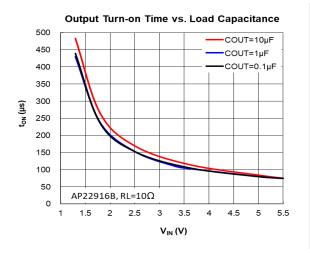


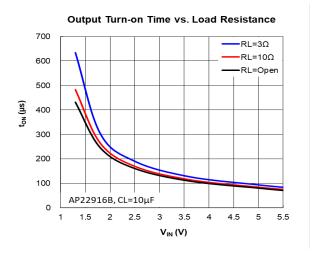


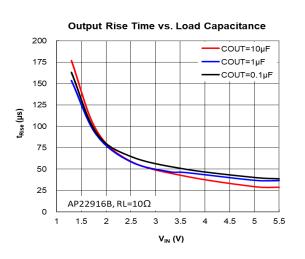


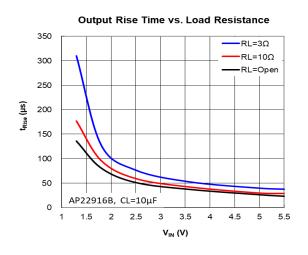


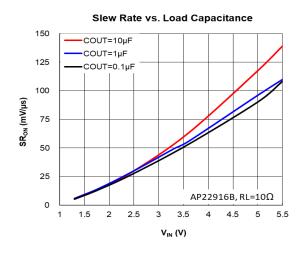


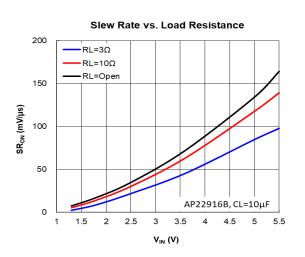




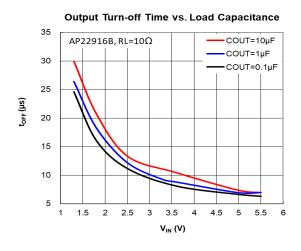


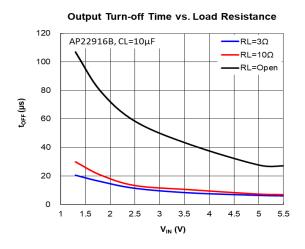


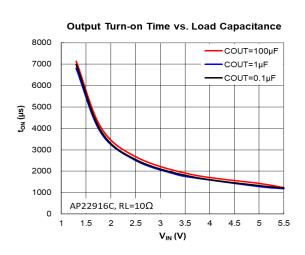


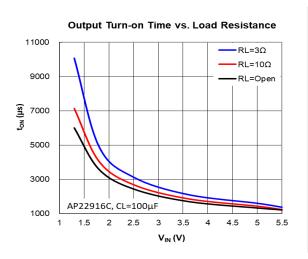


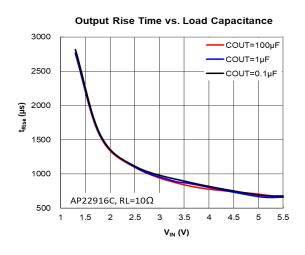


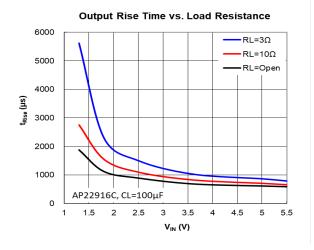




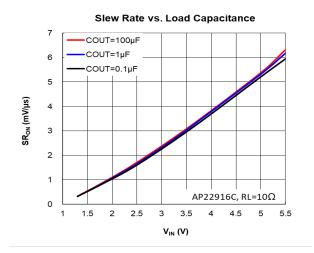


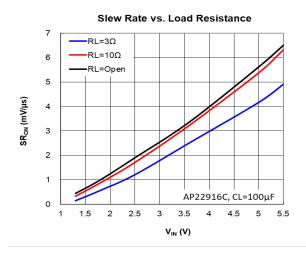




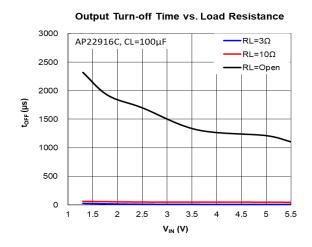


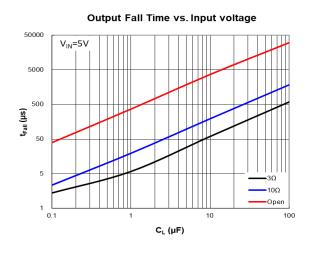


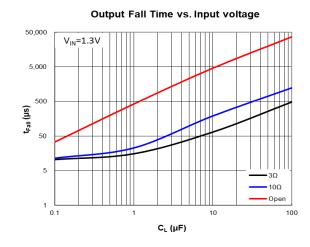




Output Turn-off Time vs. Load Capacitance 70 AP22916C, RL=10Ω COUT=1µF 60 -COUT=0.1µF 50 40 30 20 10 0 1.5 2 2.5 3.5 4.5 $V_{IN}(V)$

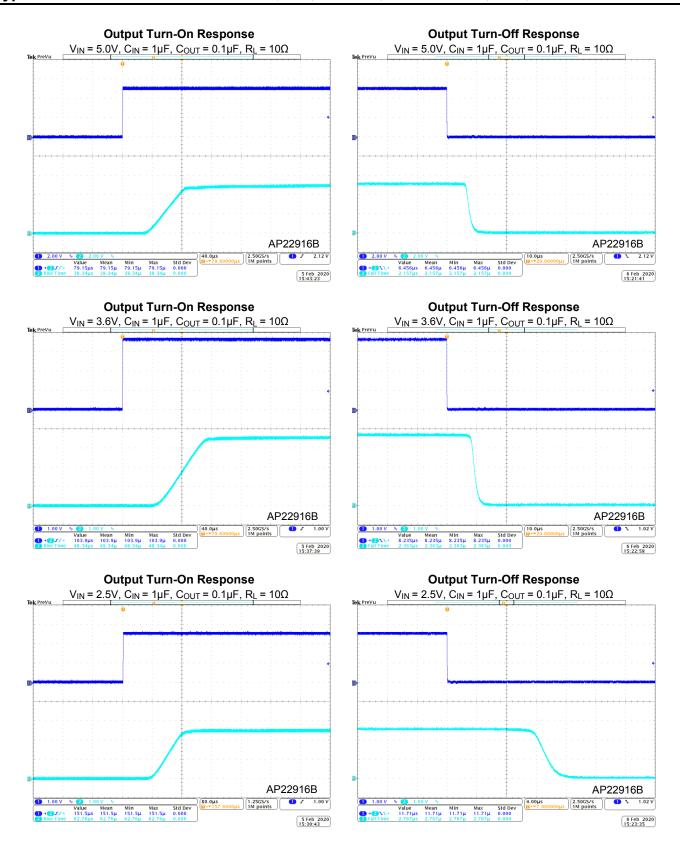




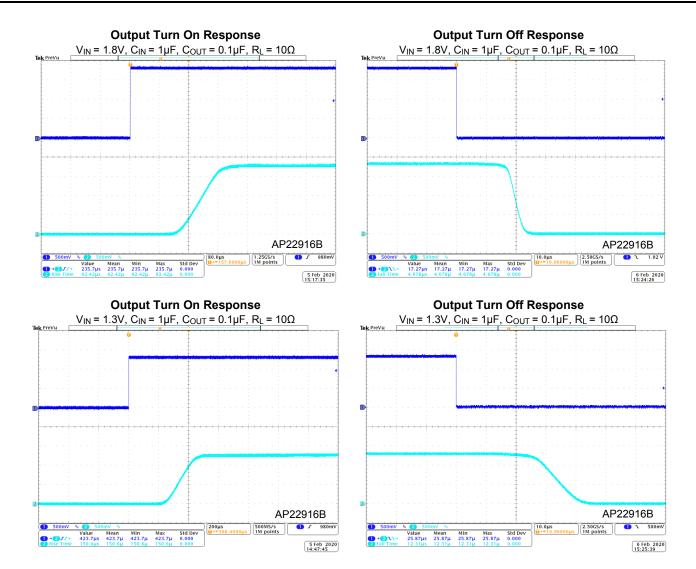




Typical Performance Characteristics (C_{IN} = 1 μF , C_{OUT} = 0.1 μF , unless otherwise specified.)

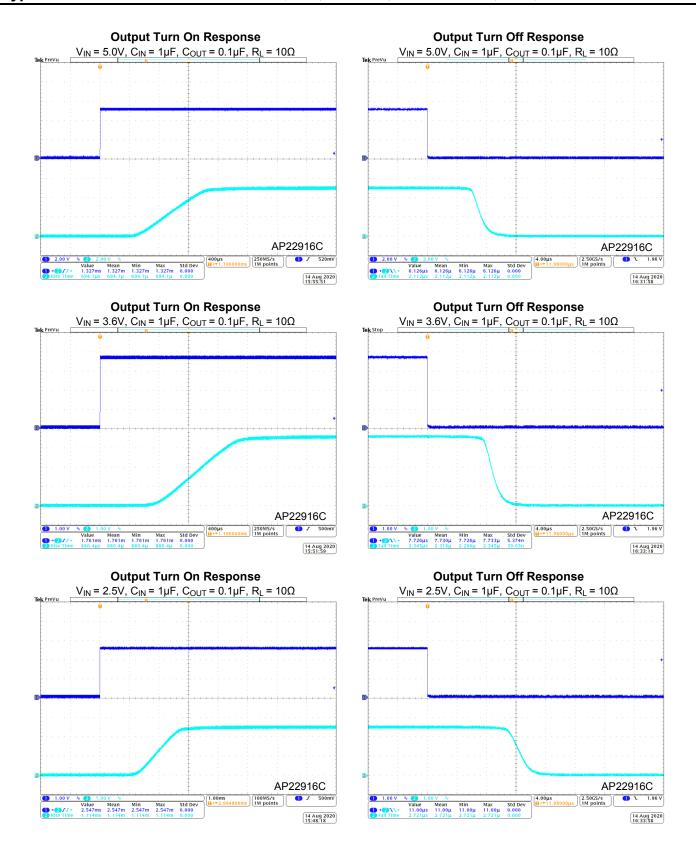




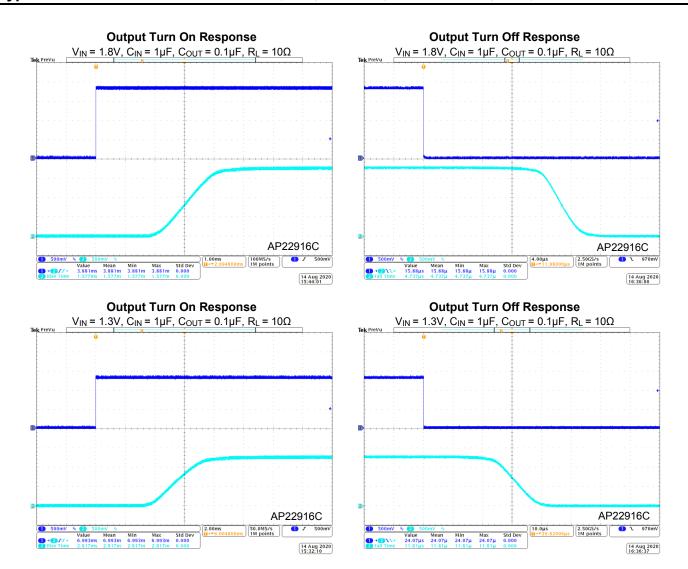




Typical Performance Characteristics (C_{IN} = 1 μF , C_{OUT} = 0.1 μF , unless otherwise specified.)









Application Information

Input Capacitor

A $1\mu F$ capacitor is recommended to connect between V_{IN} and GND pins to decouple input power supply glitch and noise. The input capacitor has no specific type or ESR (Equivalent Series Resistance) requirement. However, for higher current application, ceramic capacitors are recommended due to their capability to withstand input current surges from low impedance sources, such as batteries in portable applications. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND.

Output Capacitor

The $0.1\mu\text{F}$ to $1\mu\text{F}$ capacitor is recommended to connect between V_{OUT} and GND pins to stabilize and accommodate load transient condition. The output capacitor has no specific type or ESR requirement. The amount of the capacitance may be increased without limit. For PCB layout, the output capacitor must be placed as close as possible to V_{OUT} and GND pins, and keep the traces as short as possible.

Enable/Shutdown Operation

The AP22916 is turned on by setting the ON pin high, and is turned off by pulling it low. To ensure proper operation, the signal source used to drive the ON pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section under V_{IL} and V_{IH} .

True Reverse Current Blocking

An internal reverse voltage comparator disables the power-switch when the output voltage (V_{OUT}) is driven higher than the input voltage (V_{IN}), by V_{RCB} , to quickly (10µs typ) stop the flow of current towards the input side of the switch.

Reverse current protection is always active, even when the power switch is disabled. Additionally, under-voltage lockout (UVLO) protection turns the switch off if the input voltage is too low.

Discharge Operation

The AP22916 offers discharge option that helps to discharge the output charge when disabled.

Power Dissipation

The maximum IC junction temperature should be restricted to +125°C under normal operating conditions. The device power dissipation and proper sizing of the thermal plane are critical to avoid thermal shutdown and ensure reliable operation. Power dissipation of the device depends on input voltage and load conditions and can be calculated by:

$$P_{D} = I_{OUT}^{2} x R_{DSON}$$
 (1)

However, the maximum power dissipation that can be handled by the device depends on the maximum junction to ambient thermal resistance, maximum ambient temperature, and maximum device junction temperature, which can be approximated by the equation below:

$$P_{D(MAX)} = \frac{(125^{\circ}C - T_A)}{\theta_{JA}}$$
 (2)

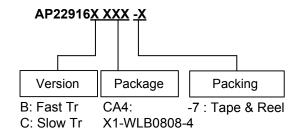
Layout Guildline

Good PCB layout is important for improving the thermal performance of the device. All trace lengths should be kept as short as possible. The input (V_{IN}) and output (V_{OUT}) PCB traces should be as wide as possible to reduce stray impedance.

Use a ground plane to enhance the power dissipation capability of the device if applicable. Place input and output capacitors close to the device to minimize the effects of parasitic inductance.



Ordering Information



Part Number	Packago Codo	Packaging	7" Tape	and Reel
Fait Number	Package Code	Packaging	Quantity	Part Number Suffix
AP22916BCA4-7	CA4	X1-WLB0808-4	3,000/Tape & Reel	-7
AP22916CCA4-7	CA4	X1-WLB0808-4	3,000/Tape & Reel	-7

Marking Information

(Top View)



X: Identification Code

Y: Year: 0~9

W: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents

52 and 53 week

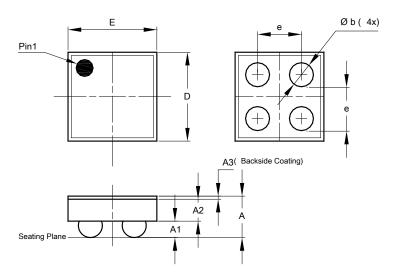
Part Number	Package	Identification Code
AP22916BCA4-7	X1-WLB0808-4	5
AP22916CCA4-7	X1-WLB0808-4	<u>-</u> 6



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-WLB0808-4

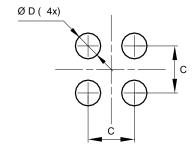


	X1-WLB0808-4						
Dim	Min	Max	Тур				
Α		0.4180					
A1	0.1350	0.1650	0.1500				
A2	0.1750	0.2250	0.2000				
A3	0.0220	0.0280	0.0250				
b	0.1971	0.2409	0.2190				
D	0.7900	0.8300	0.8100				
E	0.7900 0.8300 0.8100						
е	0.400 BSC						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-WLB0808-4



Dimensions	Value
פווטופוופווום	(in mm)
С	0.4000
D	0.2190



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